# KF560C30BBEK2-32TR

32GB (16GB 2G x 64-Bit x 2 pcs.) DDR5-6000 CL30 288-Pin DIMM Kit



## **DEFAULT SPECIFICATIONS**

40 cycles
48ns(min.)
295ns(min.)
32ns(min.)
94 V - 0
0° C to +85° C
-55° C to +100° C

### DESCRIPTION

Kingston KF560C30BBEK2-32TR is a kit of two 2G x 64-bit (16GB) DDR5-6000 CL30 SDRAM (Synchronous DRAM) 1Rx8, memory module, based on eight 2G x 8-bit FBGA components per module. Each module kit supports AMD® EXPO v1.1 and Intel® Extreme Memory Profiles (Intel® XMP) 3.0. Total kit capacity is 32GB. Each module has been tested to run at DDR5-6000 at a low latency timing of 30-36-36 at 1.4V. The SPDs are programmed to JEDEC standard latency DDR5-4800 timing of 40-39-39 at 1.1V. Each 288-pin DIMM uses gold contact fingers. The JEDEC standard electrical and mechanical specifications are as follows:

### DEFAULT FEATURES

- Power Supply: VDD = 1.1V Typical
- VDDQ = 1.1V Typical
- VPP = 1.8V Typical
- VDDSPD = 1.8V to 2.0V
- On-Die ECC
- Height 1.37" (34.88mm), w/heatsink

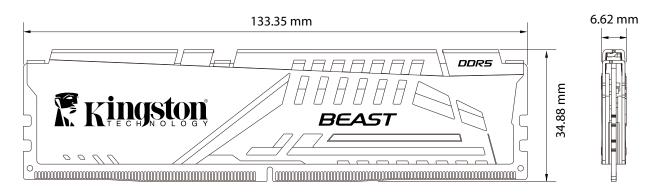
#### FACTORY TIMING PARAMETERS

<ul> <li>Default (JEDEC):</li> </ul>	DDR5-4800 CL40-39-39 @1.1V

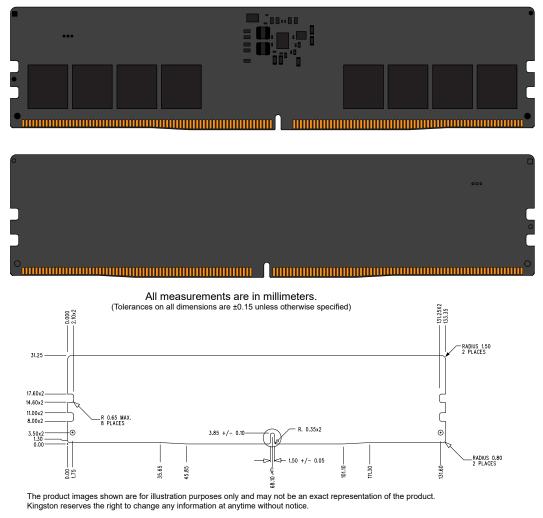
- EXPO Profile #0: DDR5-6000 CL30-36-36 @1.4V
- EXPO Profile #1: DDR5-5600 CL40-40-40 @1.25V
- XMP Profile #1: DDR5-6000 CL30-36-36 @1.4V
- XMP Profile #2: DDR5-5600 CL40-40-40 @1.25V

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#### MODULE WITH HEAT SPREADER



#### MODULE DIMENSIONS



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All Kingston products are tested to meet our published specifications. Some motherboards or system configurations may not operate at the published Kingston memory speeds and timing settings. Kingston does not recommend that any user attempt to run their computers faster than the published speed. Overclocking or modifying your system timing may result in damage to computer components.